PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Kao-Way Tu	12/29/2008
Cheng-Hui Tung	12/29/2008

RECEIVING PARTY DATA

Name:	Niko Semiconductor Co., Ltd.	
Street Address:	13F2, No. 23, Lane 169 Kangning St.	
Internal Address:	Sijhih City	
City:	Taipei County	
State/Country:	TAIWAN	
Postal Code:	221	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	12403660

CORRESPONDENCE DATA

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ATTORNEY DOCKET NUMBER:	GIAN-12631
NAME OF SUBMITTER:	Albert L. Schmeiser

Total Attachments: 1

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REEL: 022392 FRAME: 0340

500806344

Docket No.: GIAN-12631

ASSIGNMENT

Whereas, we

(1) TU, KAO-WAY; TUNG, CHENG-HUI

have invented certain improvements in a:

SEMICONDUCTOR STRUCTURE AND FABRICATION METHOD THEREOF (Title)

And whereas, NIKO SEMICONDUCTOR CO., LTD., a Corporation of Taiwan. R.O.C., having a place at 13F.-2, No.23, Lane 169, Kangning St., Sijhih City, Taipei County 221, Taiwan (R.O.C.) (hereinafter called NIKO), desires to acquire the entire right, title and interest in the said application and invention, and to any United States and foreign patents to be obtained therefore;

Now therefore, for a valuable consideration, receipt whereof is hereby acknowledged, we, the above named, hereby sell, assign, and transfer to <u>NIKO</u>, its successors and assigns, the entire right, title and interest in the said application and invention therein disclosed for the United States and foreign countries, and all rights of priority resulting from the filing of said United States application, and we request the Commissioner of Patents to issue any Letters Patent granted upon the inventions set forth in said applications to <u>NIKO</u>, its successors and assigns; and we hereby agree that <u>NIKO</u> may apply for foreign Letters Patent on said invention and we will execute all papers necessary in connection with the United States and foreign applications when called upon to do so by

> PATENT REEL: 022392 FRAME: 0341

RECORDED: 03/13/2009